

ANTENNA Data Sheet

CS-2450-16-B

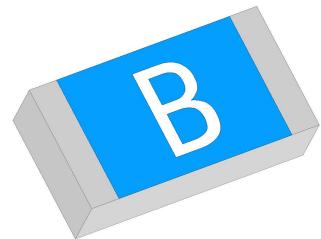
For 2400-2500MHz

1.6x0.8x0.4mm [EIA1608]

Manufacturer : Curve Technology Co., Ltd
Add : Block A, 5F, Building 12, Instrument Park, Zibo High-tech Zone,
Shandong Province, China

Feature

- Light weight, compact
- Wide bandwidth, low cost
- Built-in antenna with high gain
- Operating Temp. : -40°C~+85°C



CS-2450-16-B

Application

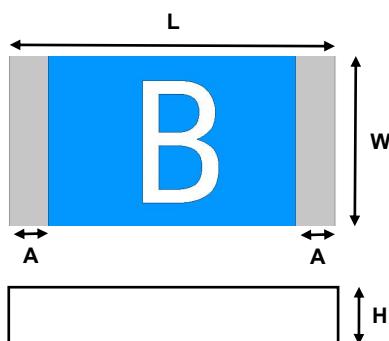
- Bluetooth
- WLAN 2.4
- WiFi 5/6/6E
- UWB

Electrical Characteristics per line(TA=25°C)

Parameter	Specification	Units
Frequency Band	2400~2500	MHz
Polarization	Linear	
*Peak Gain	2.78	dBi
*Peak Efficiency	80.25	%
Impedance	50	Ω

Test condition: Test board size 70*60 mm;
 Matching circuit: Pi matching circuit will be required.

Product Dimension



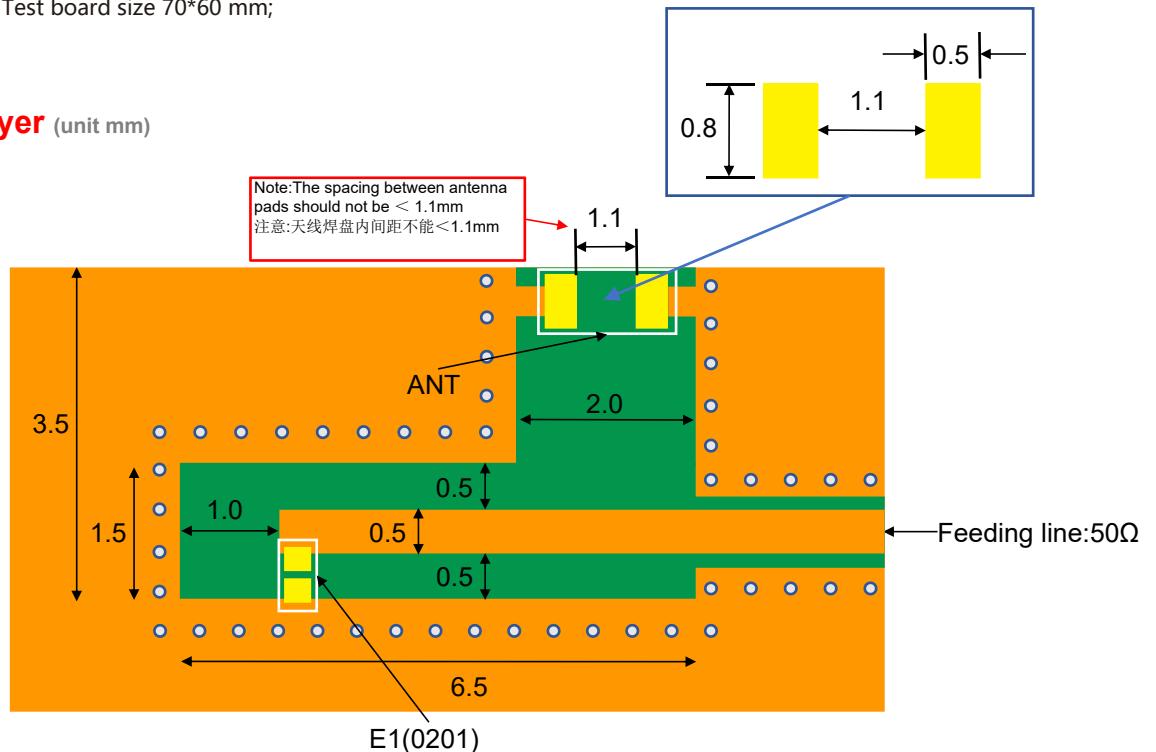
Units:mm

L	W	H	A
1.60±0.20	0.80±0.20	0.40±0.10	0.2±0.07

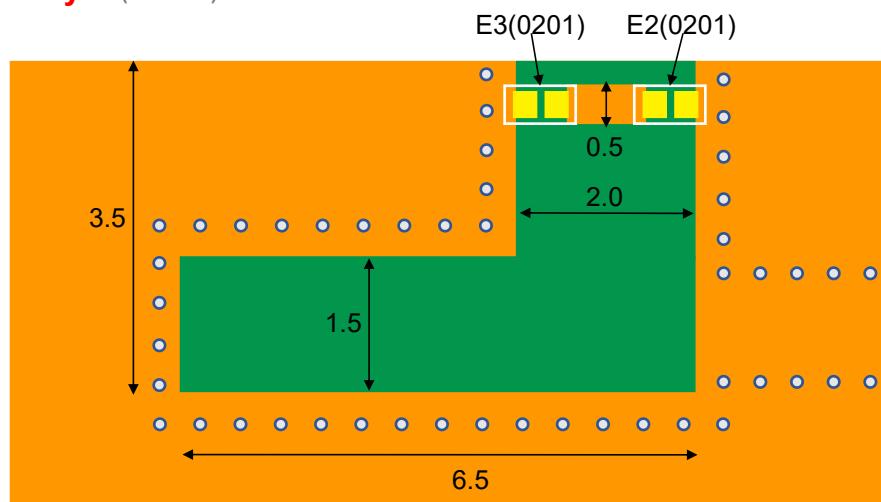
Recommend PCB Layout1

Test condition: Test board size 70*60 mm;

Top Layer (unit mm)



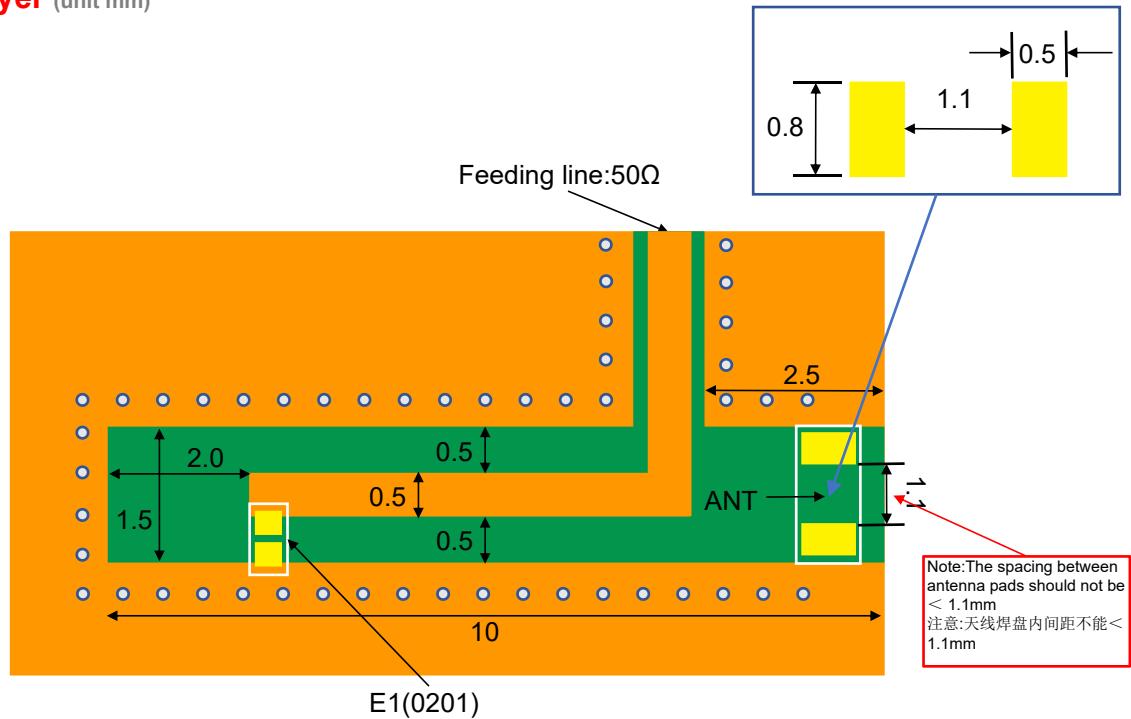
Bottom Layer (unit mm)



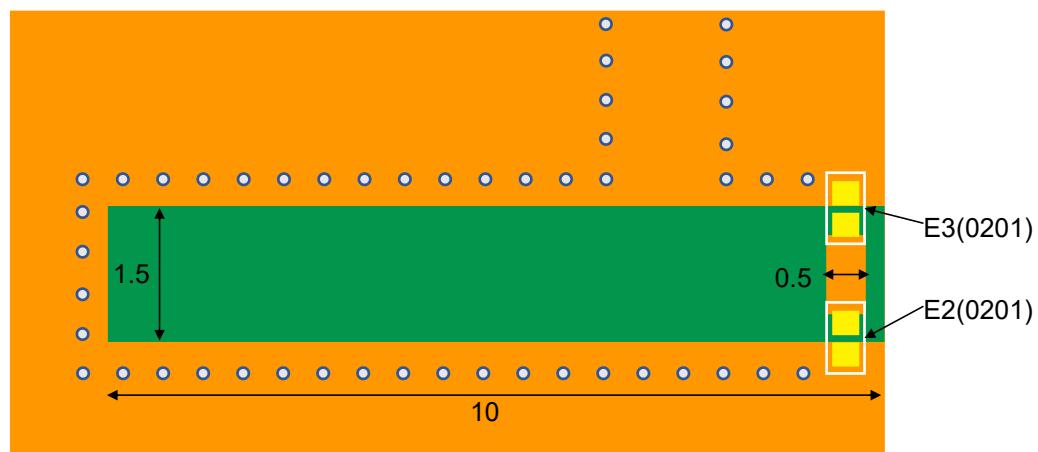
Recommend PCB Layout2

Test condition: Test board size 70*60 mm;

Top Layer (unit mm)

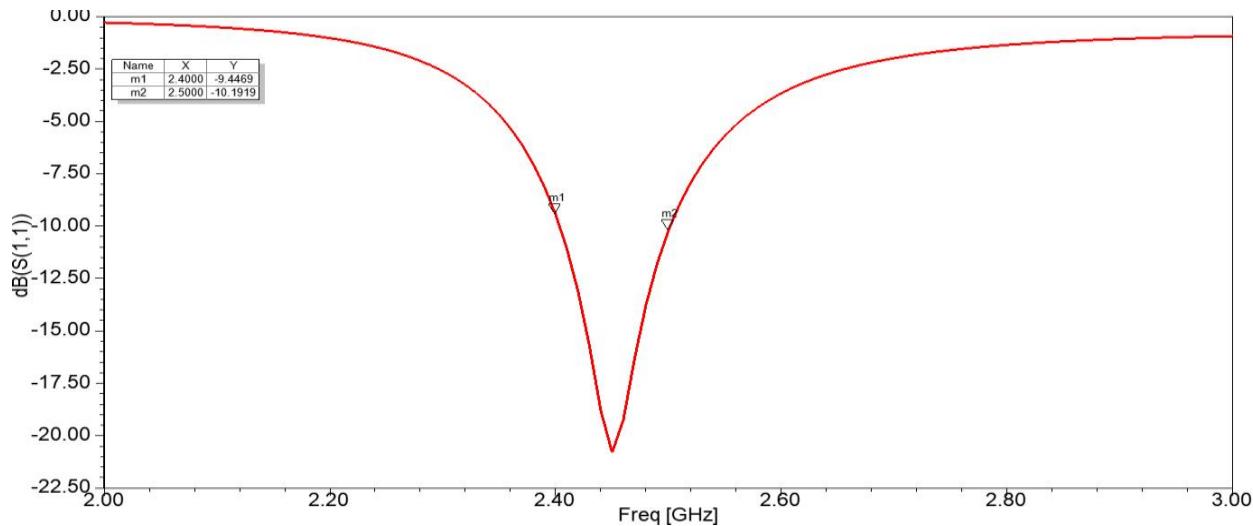


Bottom Layer (unit mm)



Typical Characteristics

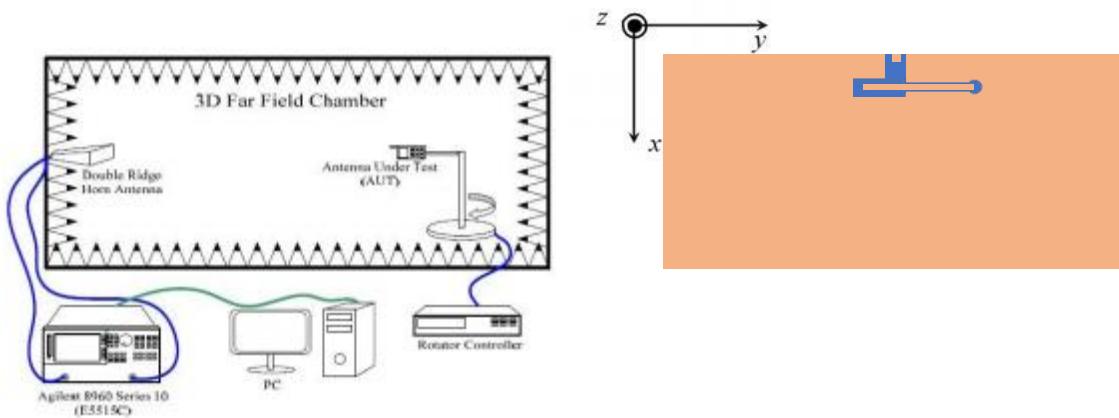
Fig. 1 Return Loss



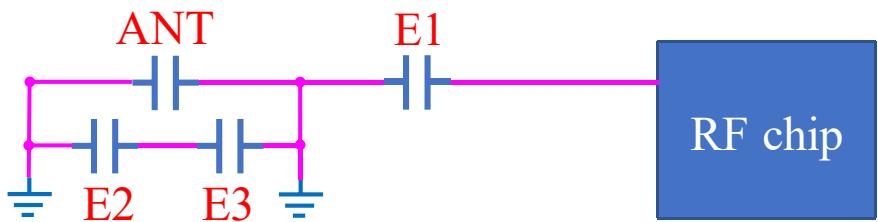
Radiation Pattern

The Gain pattern is measured in FAR -field chamber. DUT is placed on the table of rotator , a standard horn antenna and Vector Network Analyzer is used to collect data.

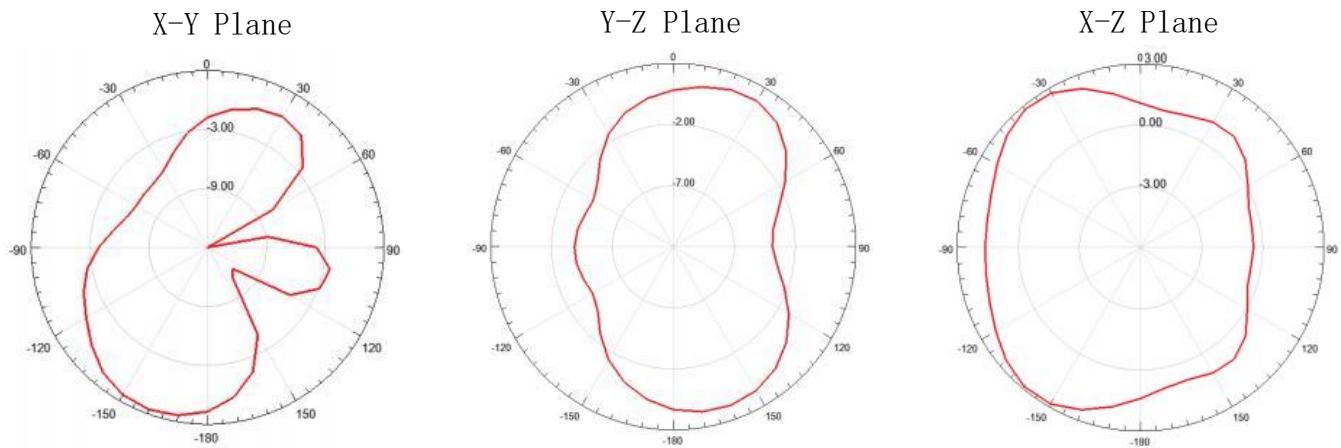
Fig.2 FAR-field Chamber



Equivalent circuit:



2D Gain Pattern



Radiation Performance:

Frequency	2400MHz	2450MHz	2500MHz
Avg. gain	-1.92	-1.35	-1.56
Peak gain	1.79	2.78	2.66
Efficiency	74.55	80.25	76.98

Item	Condition	Specification
Thermal shock	1. 30 ± 3 minutes at $-40^{\circ}\text{C}\pm5^{\circ}\text{C}$, 2. Convert to $+105^{\circ}\text{C}$ (5 minutes) 3. 30 ± 3 minutes at $+105^{\circ}\text{C}\pm5^{\circ}\text{C}$, 4. Convert to -40°C (5 minutes) 5. Total 100 continuous cycles	No apparent damage Fulfill the electrical spec. after test.
Humidity resistance	1. Humidity: 85% R.H. 2. Temperature: $85\pm5^{\circ}\text{C}$ 3. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
High temperature resistance	No apparent damage Fulfill the electrical spec. after test.	1. Temperature: $150^{\circ}\text{C}\pm5^{\circ}\text{C}$ 2. Time: 1000 hours.
Low temperature resistance	1. Temperature: $-40^{\circ}\text{C}\pm5^{\circ}\text{C}$ 2. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
Soldering heat resistance	1. Solder bath temperature : $260\pm5^{\circ}\text{C}$ 2. Bathing time: 10 ± 1 seconds	No apparent damage
Solderability	The dipped surface of the terminal shall be at least 95% covered with solder after dipped in solder bath of $245\pm5^{\circ}\text{C}$ for 3 ± 1 seconds.	No apparent damage

(2) Storage Condition

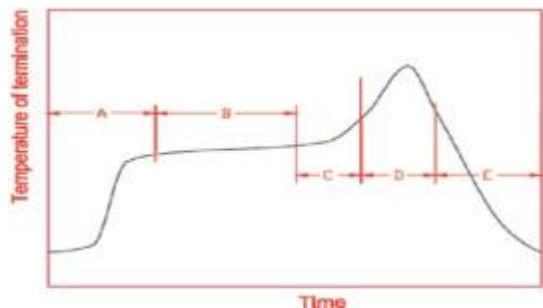
(a)At warehouse: The temperature should be within $0 \sim 30^{\circ}\text{C}$ and humidity should be less than 60% RH.The product should be used within 1 year from the time of elivery.

(b)On board: The temperature should be within $-40 \sim 85^{\circ}\text{C}$ and humidity should be less than 85% RH.

(3) Operating Temperature Range

Operating temperature range : -40°C to $+85^{\circ}\text{C}$.

Recommended Reflow Solder curve



A	1 st rising temperature	The normal to Preheating temperature	30s to 60s
B	Preheating	140°C to 160°C	60s to 120s
C	2 nd rising temperature	Preheating to 200°C	20s to 40s
D	Main heating	# 220°C	50s~60s
		# 230°C	40s~50s
		# 240°C	30s~40s
		# 250°C	20s~40s
		# 260°C	20s~40s
E	Regular cooling	200°C to 100°C	$1^{\circ}\text{C/s} \sim 4^{\circ}\text{C/s}$

*reference: J-STD-020C

(1) Soldering Gun Procedure

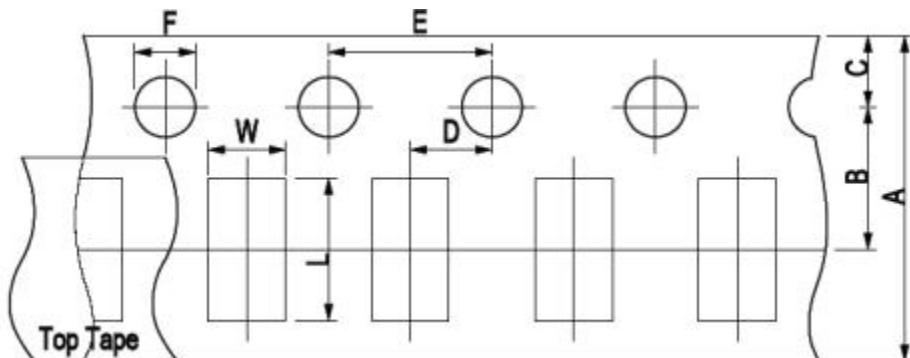
Note the follows, in case of using solder gun for replacement.

- (a) The tip temperature must be less than 350°C for the period within 3 seconds by using soldering gun under 30 W.
- (b) The soldering gun tip shall not touch this product directly.

(2) Soldering Volume

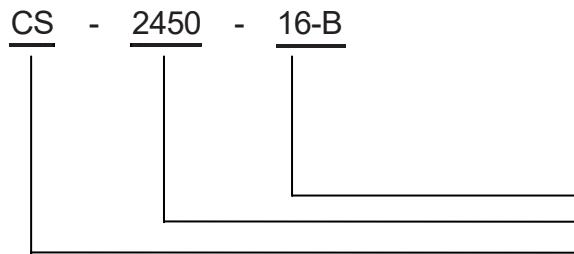
Note that excess of soldering volume will easily get crack the body of this product.

Package Information



A	B	C	D	E	F	L	W
8.00±0.3	3.50± 0.05	1.75±0.1	2.00±0.05	4.00±0.1	1.50±0.1	2.30± 0.1	1.55± 0.1

Part Number System



External Dimensions L*W (mm) 1.6*0.8

Central Frequency 2450 MHz

Product Series: Chip Antenna

Marking



订货信息 Order Information

Device	Package	Net Weight	Carrier	Quantity	HSF Status
CS-2450-16-B	1608	0.002g	Tape&Reel	5000pcs	RoHS compliant

Revision history

Date	Revision	Description of changes
2023-01-03	1.0	First Version
2023-11-15	1.1	Add PCB Layout

The contents of this data sheet are subject to change without notice.
Please confirm the specifications and delivery conditions when placing your order.

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